

A Network of Time Division Multiplexing for FPGAs

Rosemary Francis

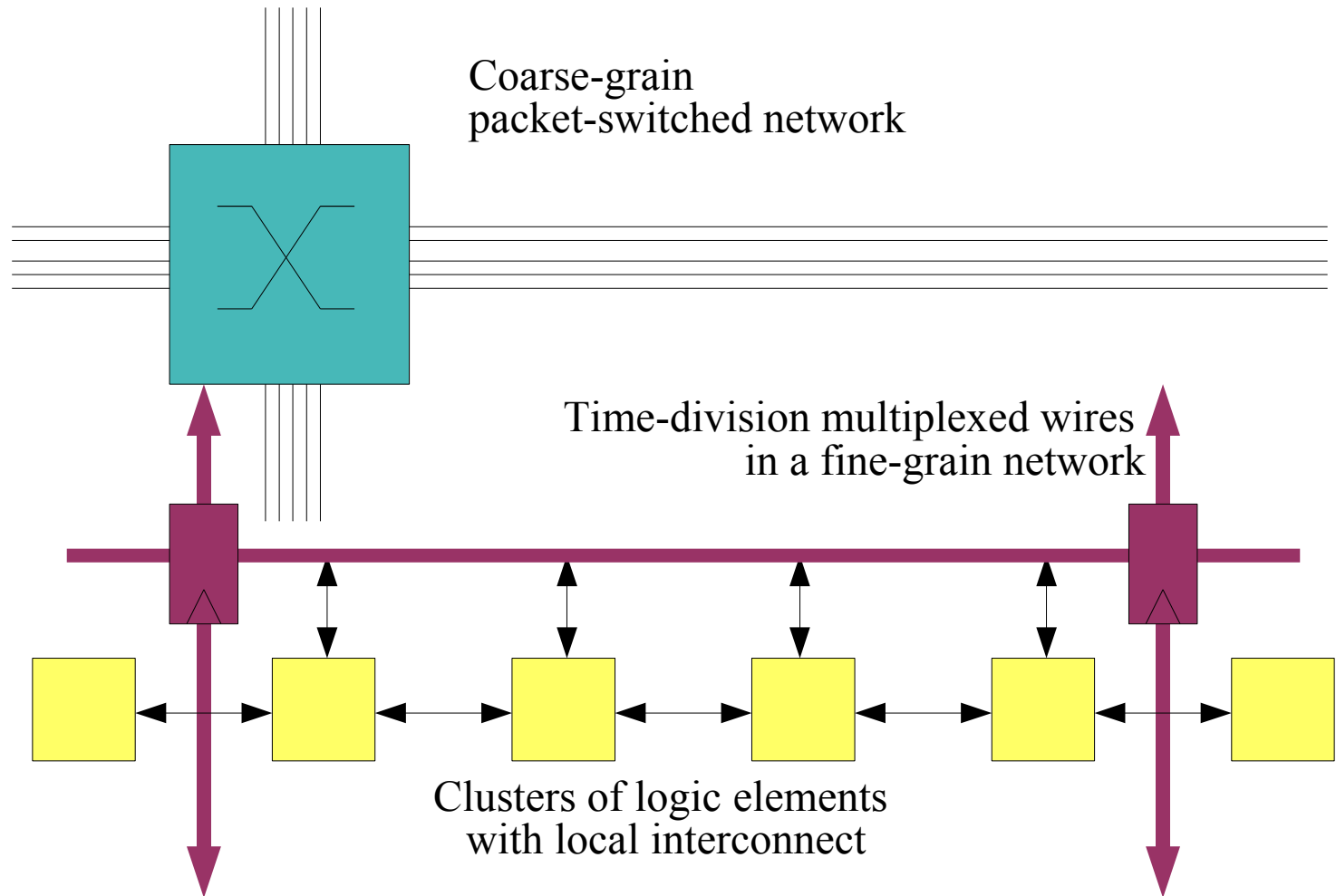
Motivation

- FPGAs are now home to complex Systems on-Chip
- Designs require the use of Network-on-Chip
- FPGA global wiring is simple in comparison with ASIC Networks-on-Chip
- Networks for FPGAs use lots of wires or lots of logic
- Hard blocks are limited by the soft IP blocks

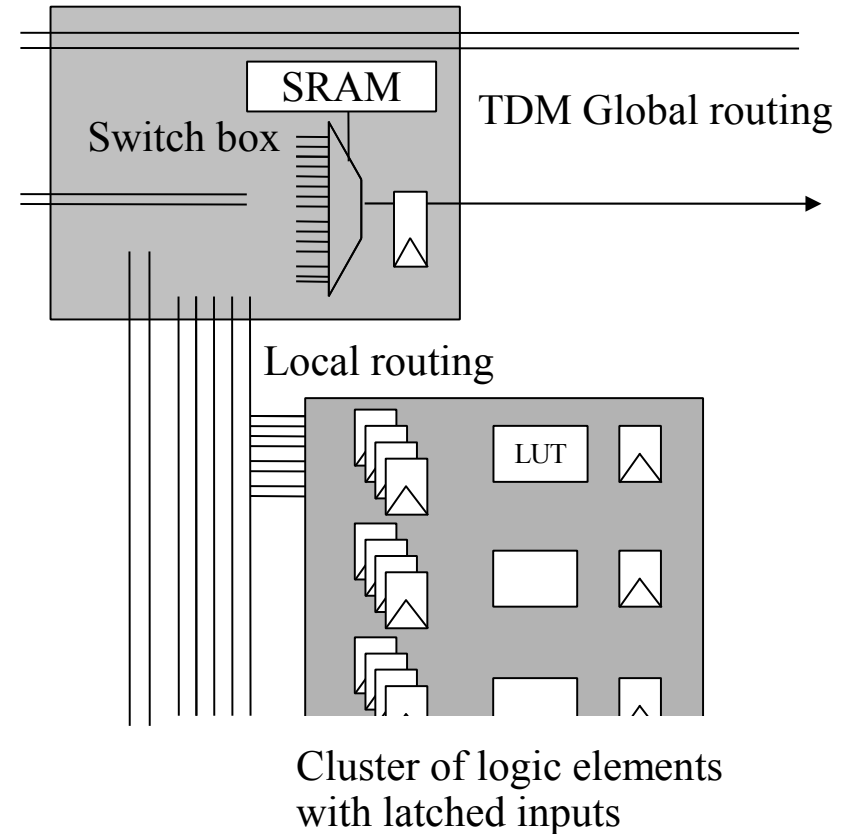
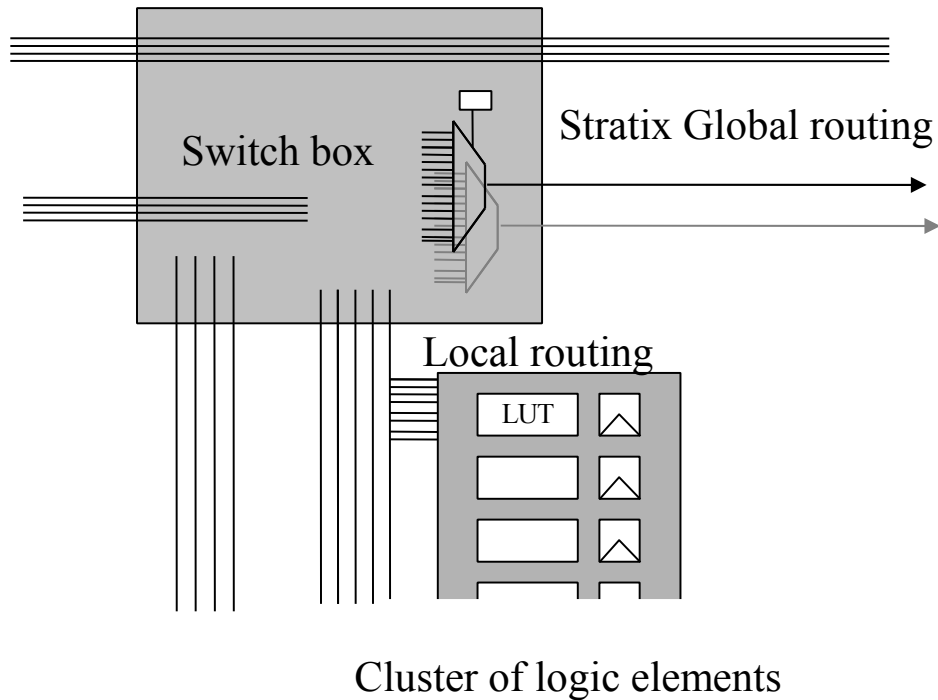
Goals

- Improve wiring density through TDM
- Use TDM components for effective soft NoC implementation
- Funnel data to high-speed hard blocks
 - Hard NoC
 - Multipliers
 - Block RAM

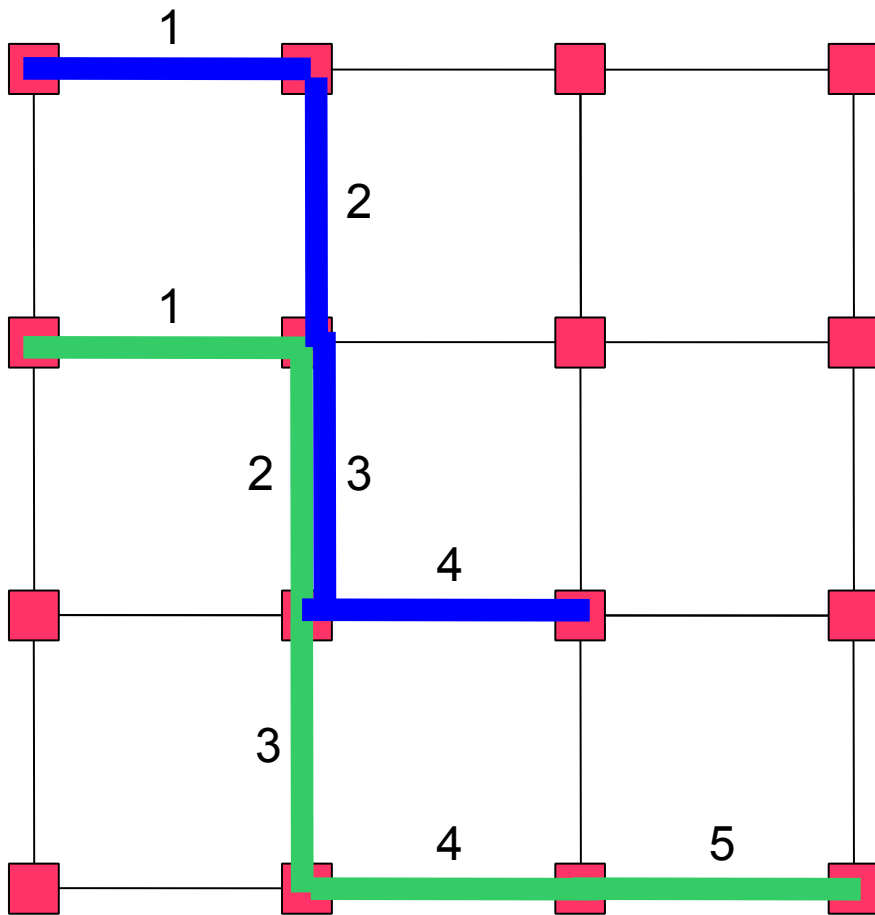
Hierarchy of interconnect



Architecture: Stratix vs TDM

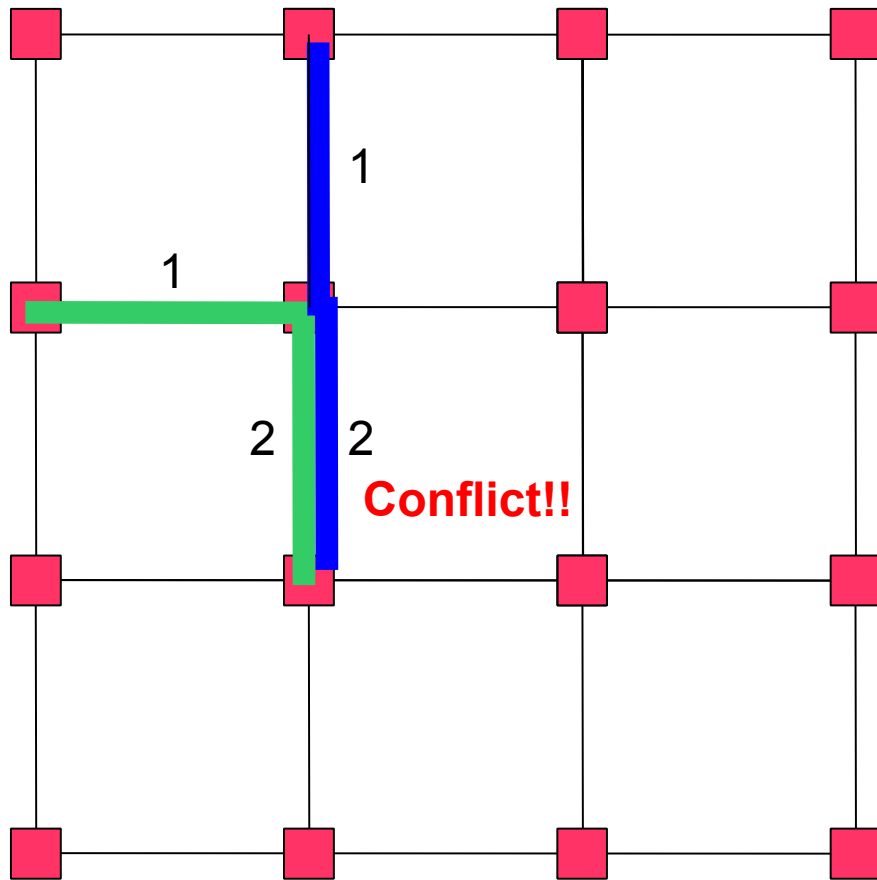


Wire Sharing



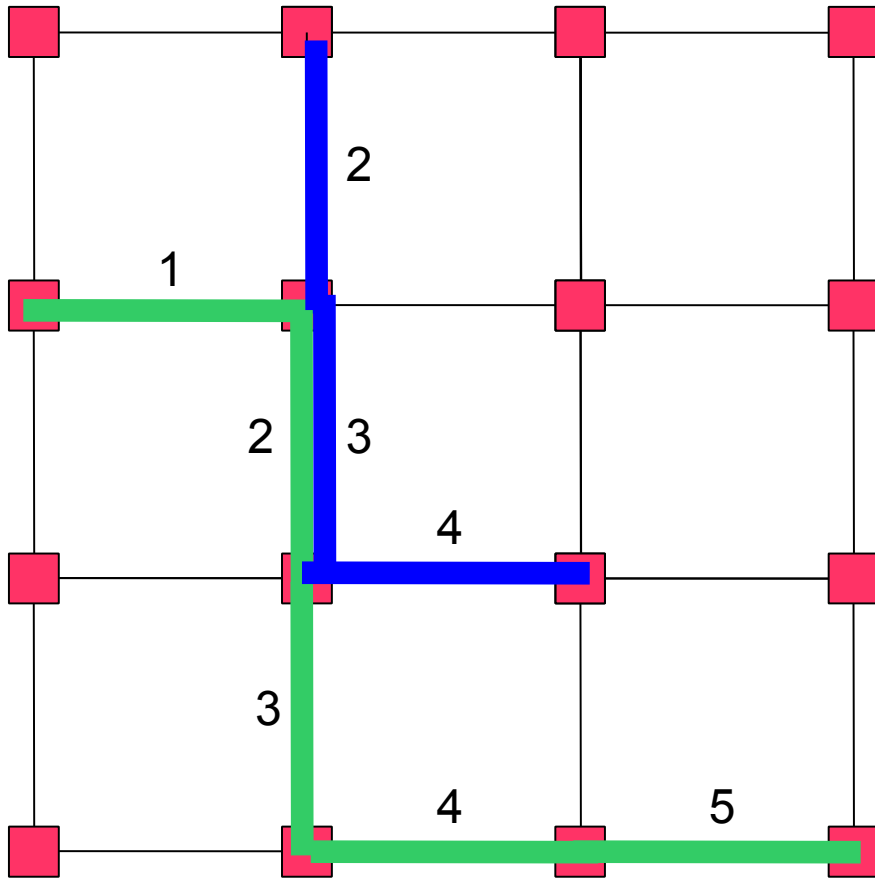
- Many wires can be shared without a problem

Wire Sharing



- Many wires can be shared without a problem
- Other configurations require a more intelligent approach

Wire Sharing

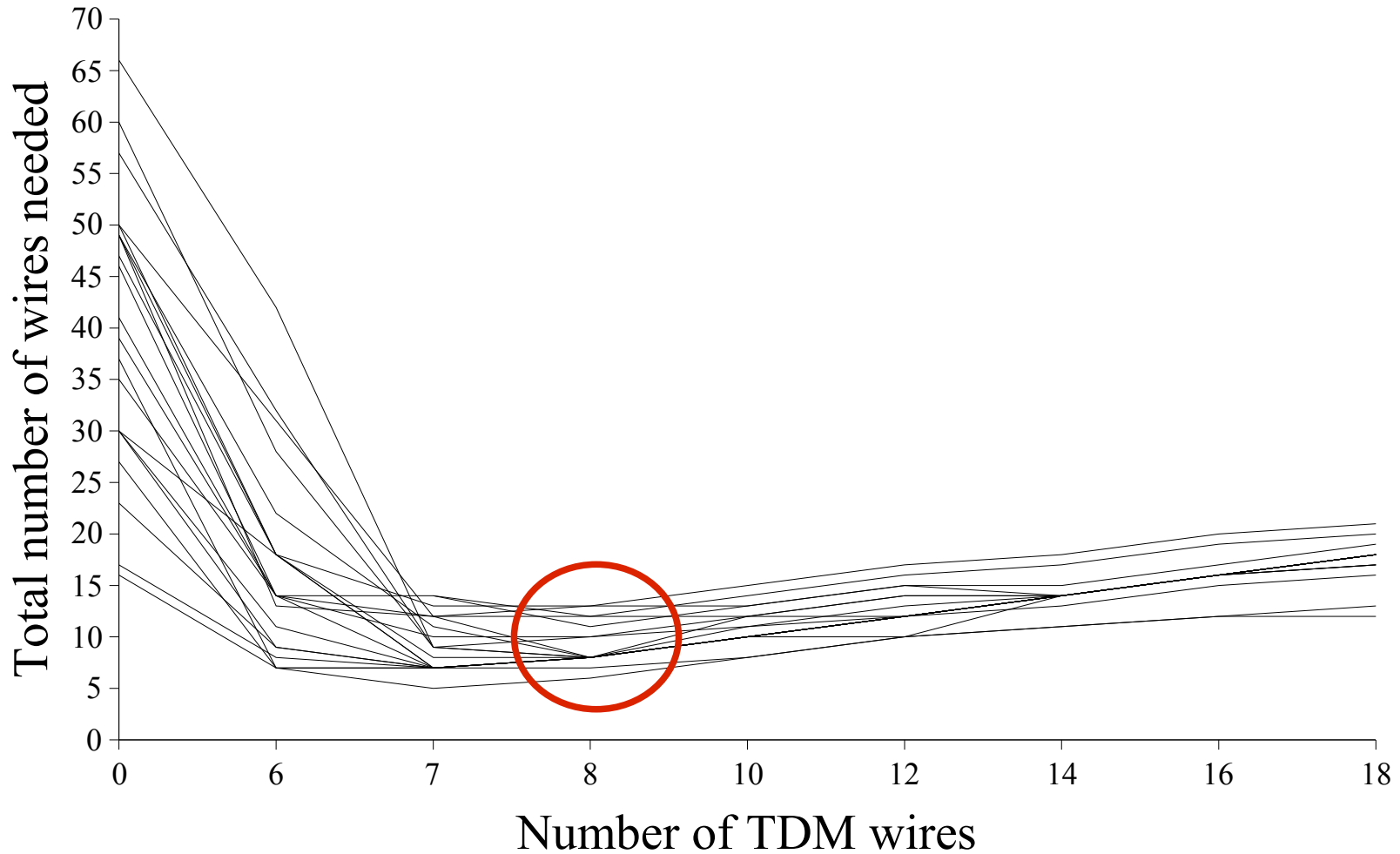


- Many wires can be shared without a problem
- Other configurations require a more intelligent approach
- Signals can be delayed to allow more efficient wire use without rerouting

Parameter selection

- Assume infinite time slots to reduce wiring
 - Determine optimum number of TDM wires

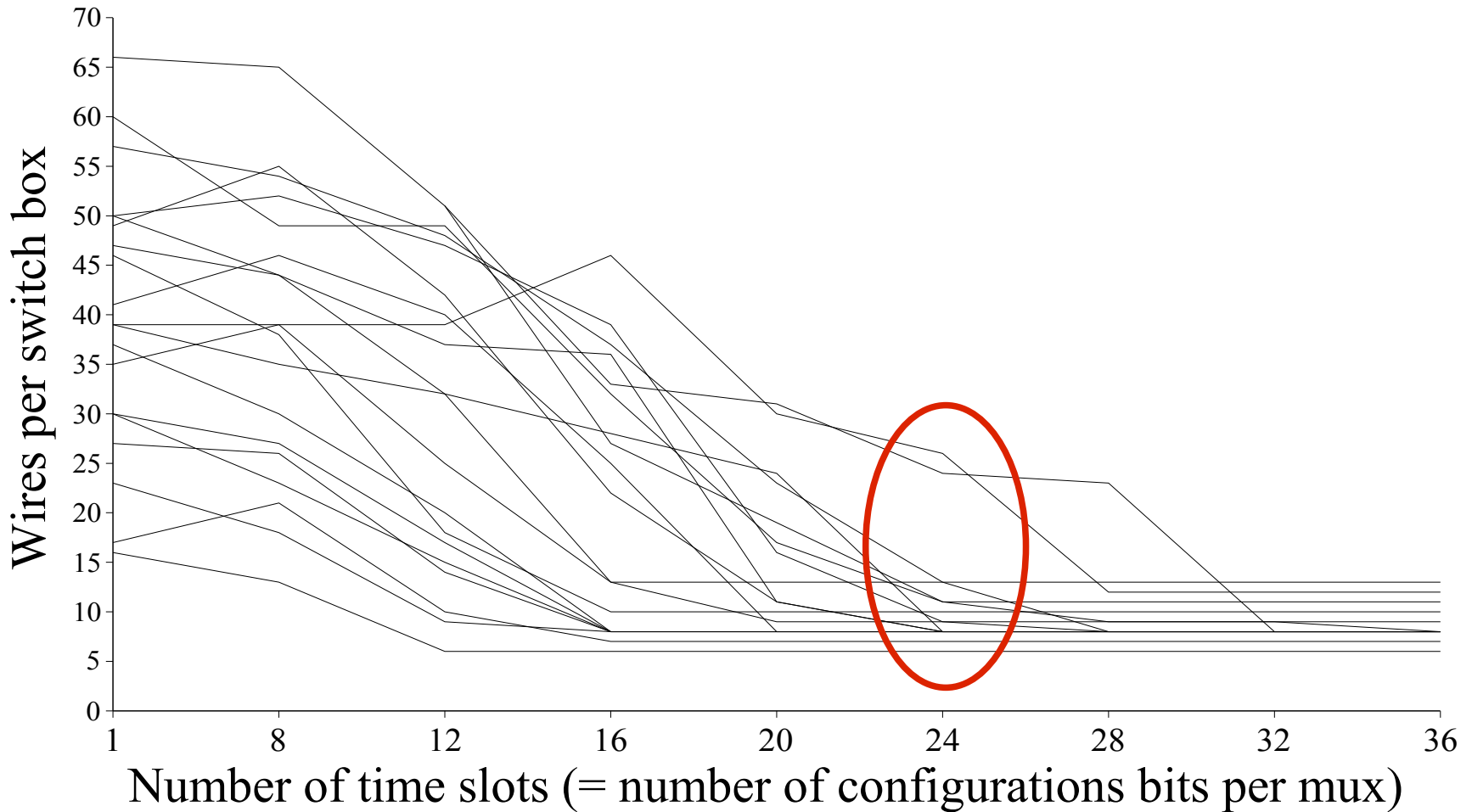
Infinite resources



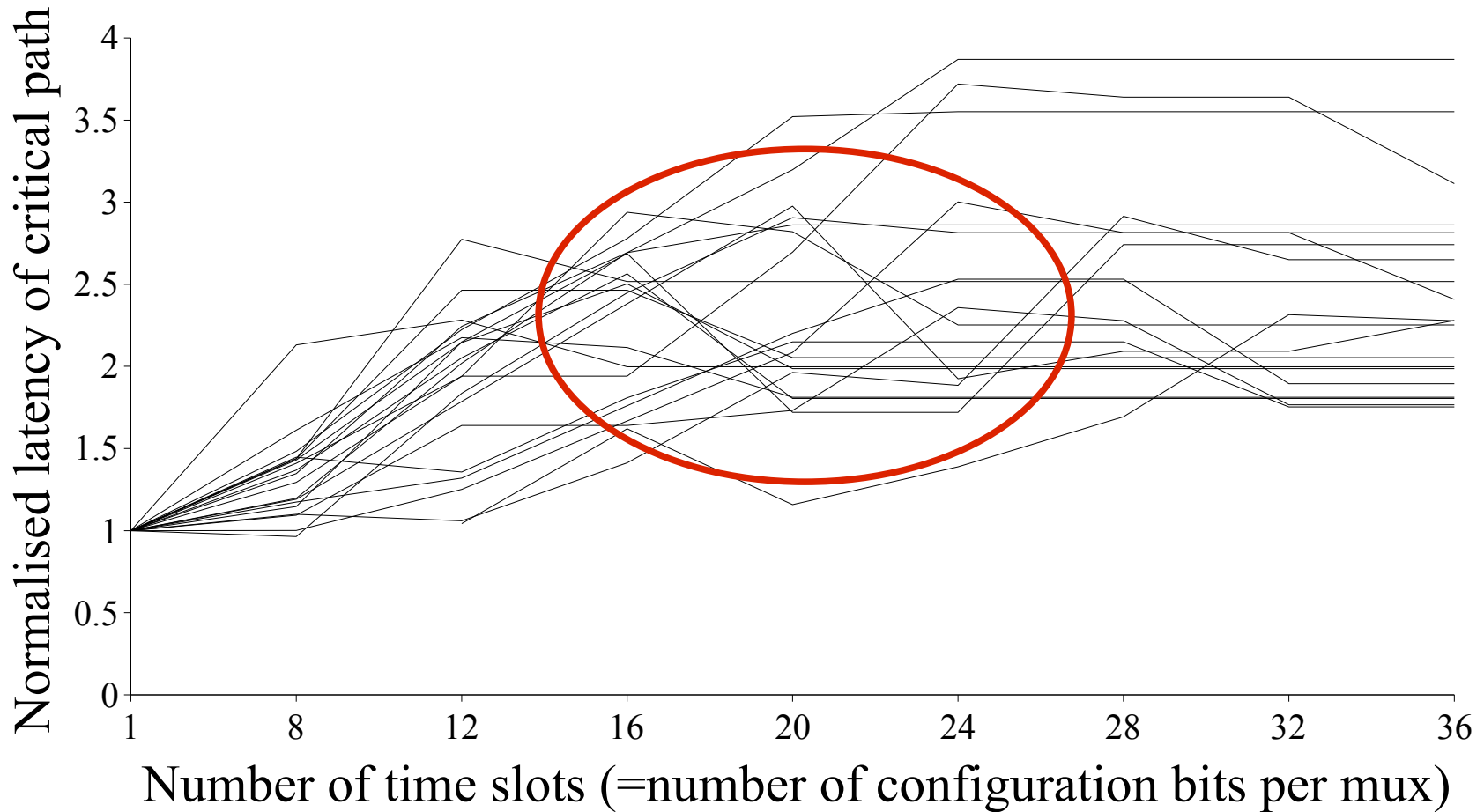
Parameter selection

- Assume infinite time slots to reduce wiring
 - Determine optimum number of TDM wires
- Vary number of time slots
 - Determine optimum number of time slots
 - Investigate the effect this has on latency

Determine number of time slots



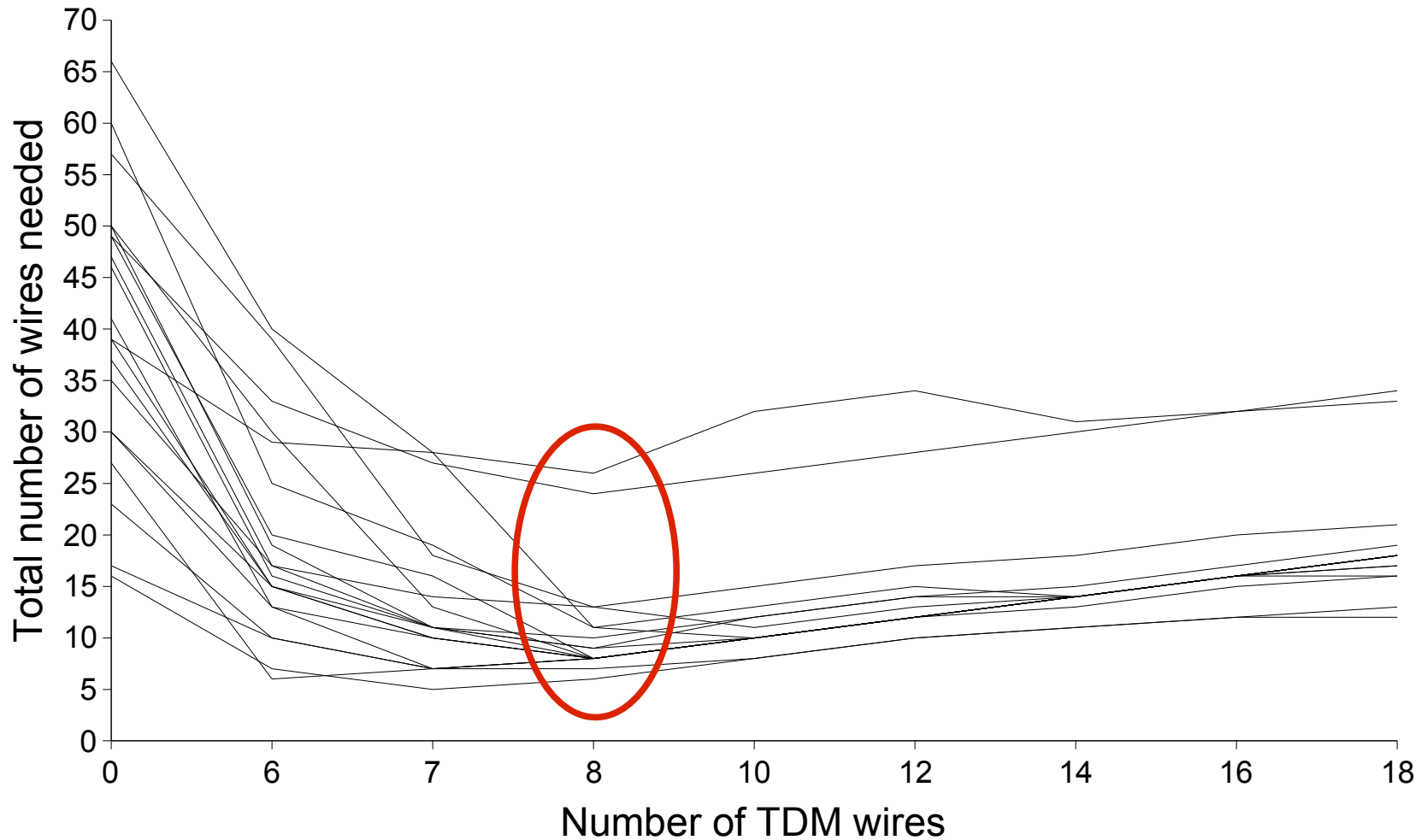
Number of time slots vs latency



Parameter selection

- Assume infinite time slots to reduce wiring
 - Determine optimum number of TDM wires
- Vary number of time slots
 - Determine optimum number of time slots
 - Investigate the effect this has on latency
- **Using optimum number of time slots**
 - Re-evaluate optimum number of TDM wires

Limited resources



Architectural drawbacks

- Extra configuration SRAM
- High-speed interconnect clock
- Benchmarks run over three times slower
- New CAD tools needed
 - Re-routing in space as well as time
 - Optimise for TDM wiring at every stage

Conclusions

- Using TDM wiring we can reduce the number of wires whilst increasing the data rate within channels
 - 75% less wiring * 24 time slots * 3 times slower means 2 times channel data rate
- This will allow
 - the design of effective global interconnect
 - more efficient sharing of on-chip resources
 - simplification of multi-chip designs

Future Work

- Current scheduling algorithm gives
 - Large wire reduction
 - Large latency penalty
- Is there a better compromise?
 - Halve the wiring, small latency penalties
- How can we reduce latency in other ways?
 - Better scheduling algorithms
 - Circuit redesign

Thanks for listening...

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